



PGA103

Programmable Gain AMPLIFIER

FEATURES

- DIGITALLY PROGRAMABLE GAINS: G=1, 10, 100V/V
- CMOS/TTL-COMPATIBLE INPUTS
- LOW GAIN ERROR: ±0.05% max, G=10
- LOW OFFSET VOLTAGE DRIFT: 2µV/°C
- LOW QUIESCENT CURRENT: 2.6mA
- LOW COST
- 8-PIN PLASTIC DIP, SO-8 PACKAGES

APPLICATIONS

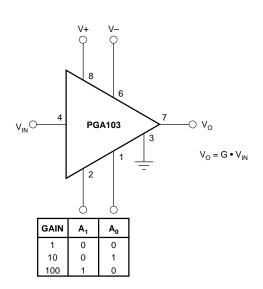
- DATA ACQUISITION SYSTEMS
- GENERAL PURPOSE ANALOG BOARDS
- MEDICAL INSTRUMENTATION

DESCRIPTION

The PGA103 is a programmable-gain amplifier for general purpose applications. Gains of 1, 10, or 100 are digitally selected by two CMOS/TTL-compatible inputs. The PGA103 is ideal for systems that must handle wide dynamic range signals.

The PGA103's high speed circuitry provides fast settling time, even at G=100 (8 μ s to 0.01%). Bandwidth is 250kHz at G=100, yet quiescent current is only 2.6mA. It operates from ±4.5V to ±18V power supplies.

The PGA103 is available in 8-pin plastic DIP and SO-8 surface-mount packages, specified for the -40° C to $+85^{\circ}$ C temperature range.



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SPECIFICATIONS

ELECTRICAL

 $\rm T_{_{A}}$ = +25°C, $\rm V_{_{S}}$ = $\pm 15 \rm V, \rm ~R_{_{L}}$ = 2k Ω unless otherwise specified.

		PGA103P, U			
PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
INPUT					
Offset Voltage, RTI					
G = 1	T _A = +25°C		±200	±1500	μV
G = 10			±100	±500	μV
G = 100			±100	±500	μV
vs Temperature	$T_A = T_{MIN}$ to T_{MAX}		_		
G = 1			±5		μV/°C
G = 10			±2		μV/°C
G = 100			±2		μV/°C
vs Power Supply G = 1	$V_s = \pm 4.5V$ to $\pm 18V$		30	70	μV/V
G = 10			10	35	μν/ν μV/V
G = 100 G = 100			10	35	μν/ν μV/V
Impedance			108 2		Ω pF
INPUT BIAS CURRENT					11 P
Initial Bias Current			±50	±150	nA
vs Temperature			±100	100	pA/°C
NOISE VOLTAGE, RTI	G = 100, R _S = 0Ω	+	+		1
f = 10Hz	$C = 100, N_{\rm S} = 0.22$		16		nV/√Hz
f = 100Hz			11		nV/√Hz
f = 1 kHz			11		nV/√Hz
$f_{\rm B} = 0.1$ Hz to 10Hz			0.6		μVp-p
		+			l
f = 10Hz			2.8		pA/√Hz
f = 1kHz			0.3		pA/vHz
$f_{\rm B} = 0.1$ Hz to 10Hz			76		pAp-p
GAIN					P' P P
Gain Error					
G = 1			±0.005	±0.02	%
G = 10			±0.02	±0.05	%
G = 100			±0.04	±0.2	%
Gain vs Temperature					
G = 1			±2		ppm/°C
G = 10			±10		ppm/°C
G = 100			±30		ppm/°C
Nonlinearity					
G = 1			±0.001	±0.003	% of FSR
G = 10			±0.002	±0.005	% of FSR
G = 100			±0.004	±0.01	% of FSR
OUTPUT					
Voltage, Positive		(V+) −3.5	(V+) -2.5		V
Negative		(V–) +3.5	(V–) +2.5		V
Load Capacitance, max			1000		pF
Short-Circuit Current			±25		mA
Bandwidth, –3dB			15		MHz
G = 1 G = 10			1.5 750		kHz
G = 10 G = 100			250		kHz kHz
Slew Rate	$V_o = \pm 10V$		9		V/µs
Settling Time, 0.1%	· · · · · · · · · · · · · · · · · · ·		Ĭ		1,40
G = 1			2		μs
G = 10			2.2		μs
G = 100			6.5		μs
Settling Time, 0.01%					
G = 1			2.5		μs
G = 10			2.5		μs
G = 100			8		μs
Overload Recovery	50% Overdrive		2.5		μs
DIGITAL LOGIC INPUTS					
Digital Low Voltage		-5.6		0.8	V
Digital Low or High Current			1		μΑ
Digital High Voltage		2	1	V+	V



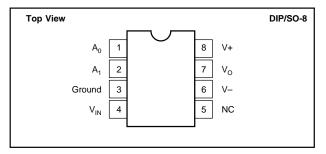
SPECIFICATIONS (CONT)

ELECTRICAL

 $\rm T_{A}$ = +25°C, $\rm V_{S}$ = ±15V, $\rm R_{L}$ = 2k\Omega unless otherwise specified.

		PGA103P, U				
PARAMETER	CONDITIONS	MIN	ТҮР	МАХ	UNITS	
POWER SUPPLY						
Voltage Range		±4.5	±15	±18	V	
Current	$V_{IN} = 0V$		±2.6	±3.5	mA	
TEMPERATURE RANGE						
Specification		-40		+85	°C	
Operating		-40		+125	°C	
θ_{JA} : P or U Package			100		°C/W	

PIN CONFIGURATION



ORDERING INFORMATION

MODEL	PACKAGE	TEMPERATURE RANGE	
PGA103P	8-Pin Plastic DIP	−40°C to +85°C	
PGA103U	SO-8 Surface-Mount	−40°C to +85°C	

ELECTROSTATIC DISCHARGE SENSITIVITY

Any integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet published specifications.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage	±18V
Analog Input Voltage Range	V– to V+
Logic Input Voltage Range	V– to V+
Output Short Circuit (to ground)	Continuous
Operating Temperature	–40°C to +125°C
Storage Temperature	–40°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering,10s)	+300°C

PACKAGE INFORMATION

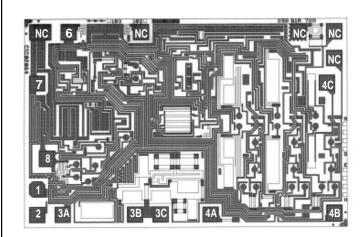
MODEL	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾
PGA103P	8-Pin Plastic DIP	006
PGA103U	SO-8 Surface-Mount	182

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

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DICE INFORMATION



PGA103 DIE TOPOGRAPHY

PAD	FUNCTION
1	A ₀
2	A ₁
3A, 3B, 3C ⁽¹⁾	Ground
4A, 4B, 4C ⁽²⁾	V _{IN}
6	V-
7	Vo
8	V+

NC: No Connection

NOTES: (1) Connect all three indicated pads. (2) Connect all three indicated pads.

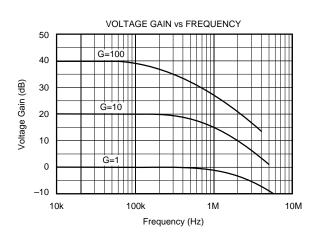
Substrate Bias: Internally connected to V- power supply.

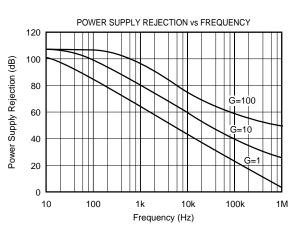
MECHANICAL INFORMATION

	MILS (0.001")	MILLIMETERS
Die Size	69 x 105 ±5	1.75 x 2.67 ±0.13
Die Thickness	20 ±3	0.51 ±0.08
Min. Pad Size	4 x 4	0.1 x 0.1
Backing		Gold

TYPICAL PERFORMANCE CURVES

 T_{A} = +25°C, V_{S} = $\pm 15 V$ unless otherwise noted.

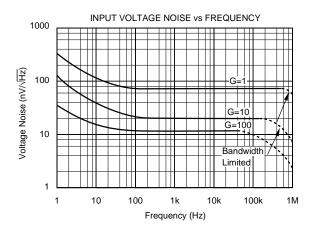


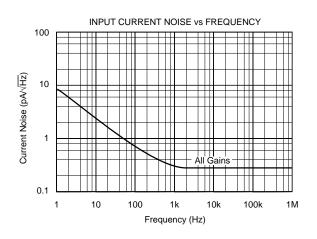




TYPICAL PERFORMANCE CURVES (CONT)

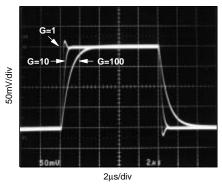
 T_{A} = +25°C, V_{S} = $\pm 15 V$ unless otherwise noted.

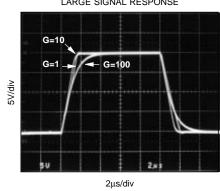




QUIESCENT CURRENT vs TEMPERATURE 4 Quiescent Current (mA) 3 2 1 0 -25 0 25 50 75 100 125 -50 Temperature (°C)

SMALL SIGNAL RESPONSE





LARGE SIGNAL RESPONSE



PGA103

APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the PGA103. Applications with noisy or high impedance power supplies may require decoupling capacitors close to the device pins as shown.

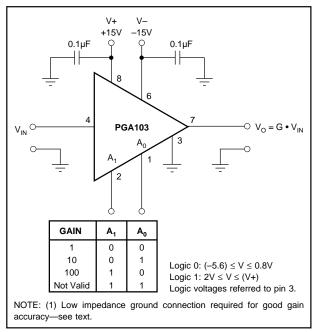


FIGURE 1. Basic Connections.

The input and output are referred to the ground terminal, pin 3. This must be a low-impedance connection to assure good gain accuracy. A resistance of 0.1Ω in series with the ground pin will cause the gain in G=100 to decrease by approximately 0.2%.

DIGITAL INPUTS

The digital inputs, A_0 and A_1 , select the gain according to the logic table in Figure 1. The digital inputs interface directly to common CMOS and TTL logic components. The logic inputs are referenced to the ground terminal, pin 3.

The logic table in Figure 1 shows that logic "1" on both A_0 and A_1 is invalid. This logic code will not cause damage, but the amplifier output will not be predictable while this code is selected. The output will recover when a valid code is selected.

The digital inputs are not latched, so a change in logic inputs immediately selects a new gain. Switching time of the logic is approximately 0.5μ s. The time to respond to gain change is equal to the switching time plus the time it takes the amplifier to settle to a new output voltage in the newly selected gain (see settling time specifications).

Many applications use an external logic latch to access gain control signals from a high speed data bus. Using an external latch isolates the high speed digital bus from sensitive analog circuitry. Locate the latch circuitry as far as practical from analog circuitry to avoid coupling digital noise into the analog circuitry. Some applications select gain of the PGA103 with switches or jumpers. Figure 2 shows pull-up resistors connected to assure a noise-free logic "1" when the switch or jumper is off or open. Fixed-gain applications can connect the logic inputs directly to V+ or ground (or other valid logic level) without a series resistor.

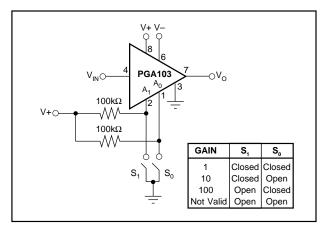


FIGURE 2. Switch or Jumper-Selected Gains.

OFFSET TRIMMING

Offset voltage is laser-trimmed to typically less than $200\mu V$ (referred to input) in all three gains. The input-referred offset voltage can be different for each gain.

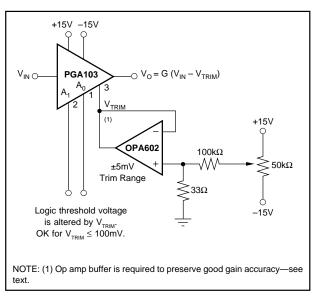
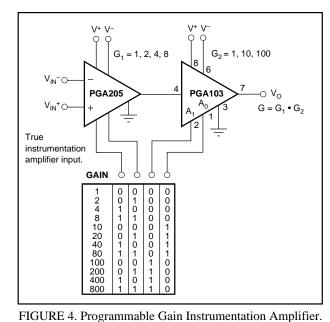


FIGURE 3. Offset Voltage Trim Circuit.

Figure 3 shows a circuit used to trim the offset voltage of the PGA103. An op amp buffers the trim voltage to provide a low impedance at the ground terminal. This is required to maintain accurate gain. Remember that the logic inputs, A_0 and A_1 , are referenced to this ground connection, so the logic threshold voltage will be affected by the trim voltage. This is insignificant if the offset adjustment is used only to trim offset voltage. If a large offset is used (greater than 0.1V), be sure that the logic input signals provide valid logic levels when referred to the voltage at the ground terminal, pin 3.





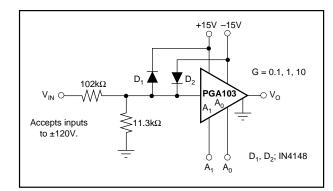


FIGURE 5. Wide Input Voltage Range Amplifer.

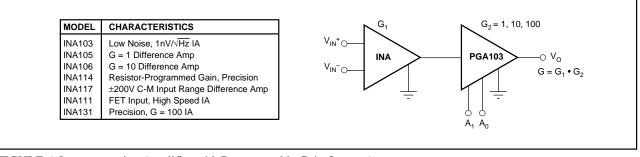


FIGURE 6. Instrumentation Amplifier with Programmable Gain Output Amp.



PGA103

PACKAGING INFORMATION

ORDERABLE DEVICE	STATUS(1)	PACKAGE TYPE	PACKAGE DRAWING	PINS	PACKAGE QTY
PGA103P	OBSOLETE	PDIP	Р	8	
PGA103U	ACTIVE	SOIC	D	8	100

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs. **LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. **PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

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